EMC Components

⊗TDK

Common mode filters Ultra high-speed differential signal line (HDMI, LVDS, MIPI, USB3.0) MCZ-DH series



MCZ1210DH_CP type



FEATURES

- O Multilayer common mode filter for ultra high-speed differential lines.
- O Widened frequency range for differential mode transmission up to 6.0GHz while ensuring common mode impedance.
- O Suppresses common mode noise without influencing the high-speed differential transmission line signal.
- \bigcirc Characteristics impedance for differential mode is 100 Ω .
- Optimal for noise suppression of ultra high-speed differential transmission lines, HDMI, USB3.0, etc.
- Operating temperature range: -40 to +85°C

APPLICATION

- O Ultra high-speed differential interfaces (HDMI,LVDS,MIPI,USB3.0)
- O Servers, PCs, DSC, DVC, TV, game, wearable equipments.
- O Application guides: Smart phones/tablets

PART NUMBER CONSTRUCTION

MCZ	1210	DH	120	CP	Т	A0G
Series name	L×W×T dimensions 1.25×1.0×0.5 mm	Product internal code	Impedance (Ω) at 100MHz	Internal code	Packaging style	Internal code

CHARACTERISTICS SPECIFICATION TABLE

Common mod	e impedance	DC resistance	Rated current	Rated voltage	Insulation resistance	Part No.
[100MHz]		[1 line]				
(Ω)	Tolerance	(Ω)max.	(mA)max.	(V)max.	(M Ω)min.	
12	$\pm 5\Omega$	1.50	100	5	10	MCZ1210DH120CPTA0G
45	±25%	2.50	100	5	10	MCZ1210DH500CPTA0G

* Impedance (Ω) at 100MHz in PART NUMBER CONSTRUCTION is a reference value.

Measurement equipment

Measurement item	Product No.	Manufacturer
Common mode impedance	4991A+16092A	Keysight Technologies
DC resistance	Type-755611	Yokogawa
Insulation resistance	4339B	Keysight Technologies

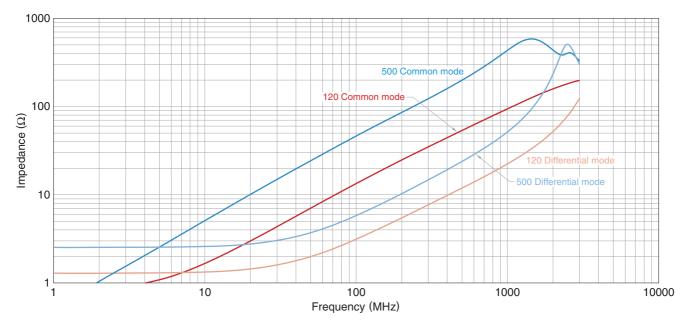
* Equivalent measurement equipment may be used.



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MCZ1210DH_CP type

■ IMPEDANCE VS. FREQUENCY CHARACTERISTICS



Measurement equipment

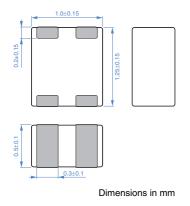
Product No.	Manufacturer
4991A+16092A	Keysight Technologies

* Equivalent measurement equipment may be used.

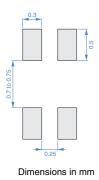
A Please be sure to request delivery specifications that provide further details on the features and specifications of the products for proper and safe use. (2/4) Please note that the contents may change without any prior notice due to reasons such as upgrading.

MCZ1210DH_CP type

SHAPE & DIMENSIONS



RECOMMENDED LAND PATTERN

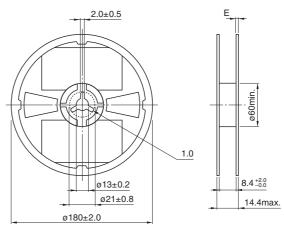


CIRCUIT DIAGRAM

No polarity

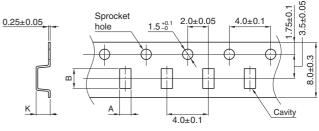
PACKAGING STYLE

REEL DIMENSIONS



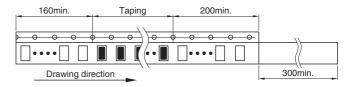
Dimensions in mm

TAPE DIMENSIONS



Dimensions in mm

Туре	А	В	К
MCZ1210DH_CP	1.17±0.03	1.40±0.03	0.63±0.03



Dimensions in mm

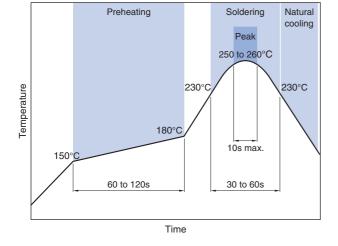
PACKAGE QUANTITY

Package quantity 4,000 pcs/reel

TEMPERATURE RANGE, INDIVIDUAL WEIGHT

Operating temperature range	Storage temperature range*	Individual weight	
–40 to +85 °C	–40 to +85 °C	3.0 mg	
* The storage temperature range is for after the assembly			

* The storage temperature range is for after the assembly



RECOMMENDED REFLOW PROFILE

Please be sure to request delivery specifications that provide further details on the features and specifications of the products for proper and safe use. (3/4) Please note that the contents may change without any prior notice due to reasons such as upgrading.

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EMC Components

REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using this products.

The storage period is less than 12 months. Be sure to follow the storage conditions (temperature: 5 to 40°C, humidity: 10 to 75% RH or less). If the storage period elapses, the soldering of the terminal electrodes may deteriorate.				
\bigcirc Do not use or store in locations where there are conditions such as g	gas corrosion (salt, acid, alkali, etc.).			
 Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature does not exceed 150°C. 	difference between the solder temperature and chip temperature			
Soldering corrections after mounting should be within the range of the conditions determined in the specifications. If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.				
• When embedding a printed circuit board where a chip is mounted to a set, be sure that residual stress is not given to the chip due to the overall distortion of the printed circuit board and partial distortion such as at screw tightening portions.				
Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.				
 Carefully lay out the coil for the circuit board design of the non-magn A malfunction may occur due to magnetic interference. 	etic shield type.			
\bigcirc Use a wrist band to discharge static electricity in your body through t	he grounding wire.			
\bigcirc Do not expose the products to magnets or magnetic fields.				
\bigcirc Do not use for a purpose outside of the contents regulated in the del	ivery specifications.			
 The products listed on this catalog are intended for use in general electronic equipment (AV equipment, telecommunications equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) under a normal operation and use condition. The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property. If you intend to use the products in the applications listed below or if you have special requirements exceeding the range or conditions set forth in the each catalog, please contact us. 				
 (1) Aerospace/aviation equipment (2) Transportation equipment (cars, electric trains, ships, etc.) (3) Medical equipment (4) Power-generation control equipment (5) Atomic energy-related equipment (6) Seabed equipment (7) Transportation control equipment 	 (8) Public information-processing equipment (9) Military equipment (10) Electric heating apparatus, burning equipment (11) Disaster prevention/crime prevention equipment (12) Safety equipment (13) Other applications that are not considered general-purpose applications 			
When designing your equipment even for general-purpose applications tection circuit/device or providing backup circuits in your equipment.	, you are kindly requested to take into consideration securing pro-			